

PEMD3; PIMD3; PUMD3

NPN/PNP resistor-equipped transistors;
R1 = 10 k Ω , R2 = 10 k Ω

Rev. 08 — 6 December 2004

Product data sheet

1. Product profile

1.1 General description

NPN/PNP resistor-equipped transistors.

Table 1: Product overview

Type number	Package		PNP/PNP complement	NPN/PNP complement
	Philips	EIAJ		
PEMD3	SOT666	-	PEMB11	PEMH11
PIMD3	SOT457	SC-74	-	-
PUMD3	SOT363	SC-88	PUMB11	PUMH11

1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

1.4 Quick reference data

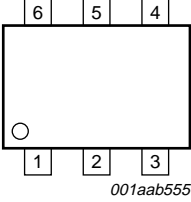
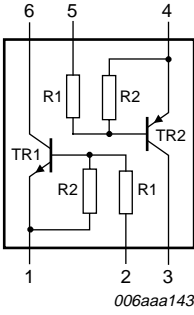
Table 2: Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
I _O	output current (DC)		-	-	100	mA
R1	bias resistor 1 (input)		7	10	13	k Ω
R2/R1	bias resistor ratio		0.8	1	1.2	

PHILIPS

2. Pinning information

Table 3: Pinning

Pin	Description	Simplified outline	Symbol
1	GND (emitter) TR1		
2	input (base) TR1		
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	output (collector) TR1		

3. Ordering information

Table 4: Ordering information

Type number	Package		Version
	Name	Description	
PEMD3	-	plastic surface mounted package; 6 leads	SOT666
PIMD3	SC-74	plastic surface mounted package; 6 leads	SOT457
PUMD3	SC-88	plastic surface mounted package; 6 leads	SOT363

4. Marking

Table 5: Marking codes

Type number	Marking code ^[1]
PEMD3	D3
PIMD3	M7
PUMD3	D*3

[1] * = -: made in Hong Kong
 * = t: made in Malaysia
 * = W: made in China

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit	
Per transistor; for the PNP transistor with negative polarity						
V _{CBO}	collector-base voltage	open emitter	-	50	V	
V _{CEO}	collector-emitter voltage	open base	-	50	V	
V _{EBO}	emitter-base voltage	open collector	-	10	V	
V _I	input voltage TR1		-	-		
	positive		-	+40	V	
	negative		-	-10	V	
	input voltage TR2		-	-		
	positive		-	+10	V	
	negative		-	-40	V	
I _O	output current (DC)		-	100	mA	
I _{CM}	peak collector current		-	100	mA	
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C				
	SOT363		[1]	-	200	mW
	SOT457		[2]	-	300	mW
	SOT666		[1] [3]	-	200	mW
T _{stg}	storage temperature		-65	+150	°C	
T _j	junction temperature		-	150	°C	
T _{amb}	ambient temperature		-65	+150	°C	
Per device						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C				
	SOT363		[1]	-	300	mW
	SOT457		[2]	-	600	mW
	SOT666		[1] [3]	-	300	mW

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, standard footprint.

[2] Device mounted on a FR4 printed-circuit board with 65 μ m copper strip line, standard footprint.

[3] Reflow soldering is the only recommended soldering method.

6. Thermal characteristics

Table 7: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per transistor						
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT363		[1]	-	625	K/W
	SOT457		[2]	-	417	K/W
	SOT666		[1][3]	-	625	K/W
Per device						
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT363		[1]	-	416	K/W
	SOT457		[2]	-	208	K/W
	SOT666		[1][3]	-	416	K/W

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, standard footprint.

[2] Device mounted on a FR4 printed-circuit board with 65 μm copper strip line, standard footprint.

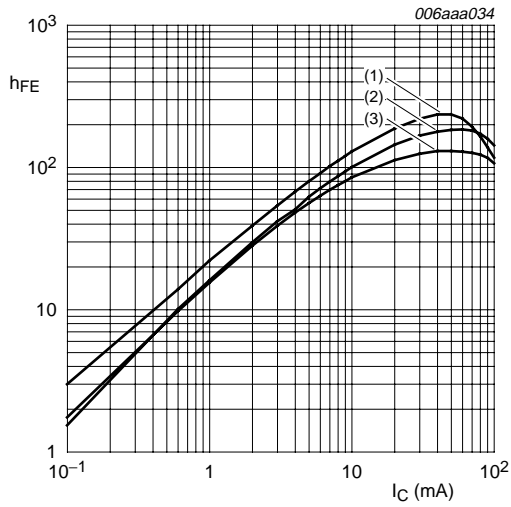
[3] Reflow soldering is the only recommended soldering method.

7. Characteristics

Table 8: Characteristics

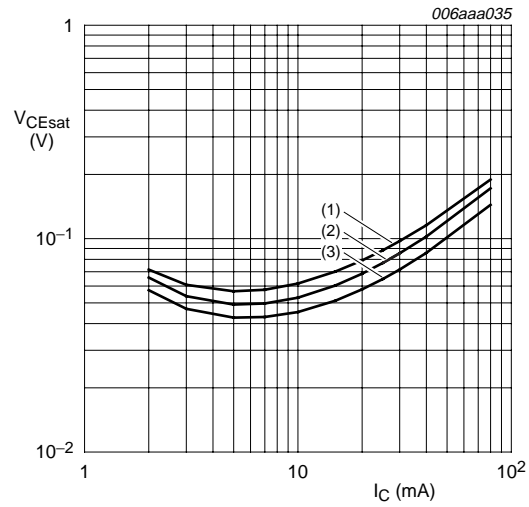
$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
Per transistor; for the PNP transistor with negative polarity							
I_{CBO}	collector-base cut-off current	$V_{CB} = 50\text{ V}; I_E = 0\text{ A}$	-	-	100	nA	
I_{CEO}	collector-emitter cut-off current	$V_{CE} = 30\text{ V}; I_B = 0\text{ A}$	-	-	1	μA	
		$V_{CE} = 30\text{ V}; I_B = 0\text{ A}; T_j = 150\text{ °C}$	-	-	50	μA	
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5\text{ V}; I_C = 0\text{ A}$	-	-	400	μA	
h_{FE}	DC current gain	$V_{CE} = 5\text{ V}; I_C = 5\text{ mA}$	30	-	-		
V_{CEsat}	collector-emitter saturation voltage	$I_C = 10\text{ mA}; I_B = 0.5\text{ mA}$	-	-	150	mV	
$V_{I(off)}$	off-state input voltage	$V_{CE} = 5\text{ V}; I_C = 100\text{ μA}$	-	1.1	0.8	V	
$V_{I(on)}$	on-state input voltage	$V_{CE} = 0.3\text{ V}; I_C = 10\text{ mA}$	2.5	1.8	-	V	
R1	bias resistor 1 (input)		7	10	13	kΩ	
R2/R1	bias resistor ratio		0.8	1	1.2		
C_c	collector capacitance	$V_{CB} = 10\text{ V}; I_E = i_e = 0\text{ A}; f = 1\text{ MHz}$					
			TR1 (NPN)	-	-	2.5	pF
			TR2 (PNP)	-	-	3	pF



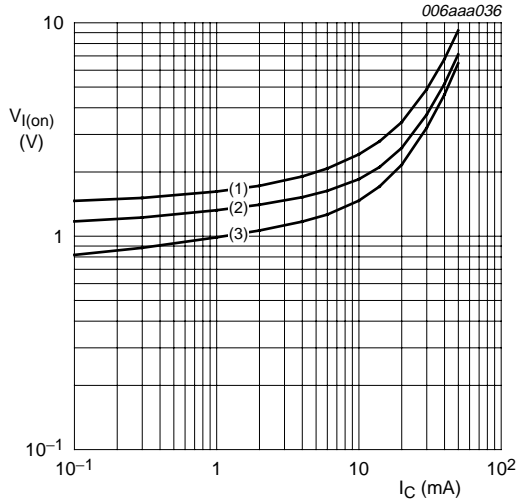
TR1; NPN: $V_{CE} = 5 \text{ V}$.
 (1) $T_{amb} = 150 \text{ }^\circ\text{C}$.
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$.
 (3) $T_{amb} = -40 \text{ }^\circ\text{C}$.

Fig 1. DC current gain as a function of collector current; typical values.



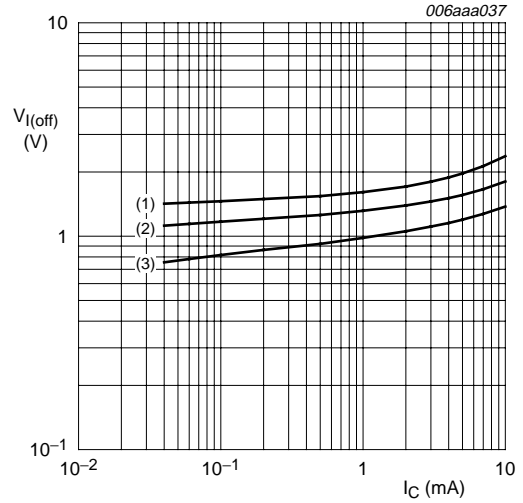
TR1; NPN: $I_C/I_B = 20$.
 (1) $T_{amb} = 100 \text{ }^\circ\text{C}$.
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$.
 (3) $T_{amb} = -40 \text{ }^\circ\text{C}$.

Fig 2. Collector-emitter voltage as a function of collector current; typical values.



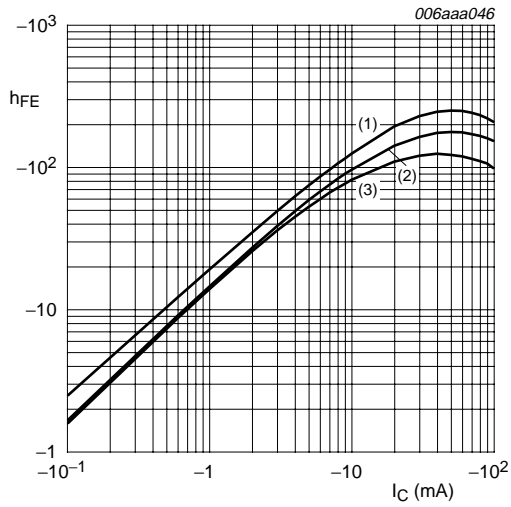
TR1; NPN: $V_{CE} = 0.3 \text{ V}$.
 (1) $T_{amb} = -40 \text{ }^\circ\text{C}$.
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$.
 (3) $T_{amb} = 100 \text{ }^\circ\text{C}$.

Fig 3. On-state input voltage as a function of collector current; typical values.



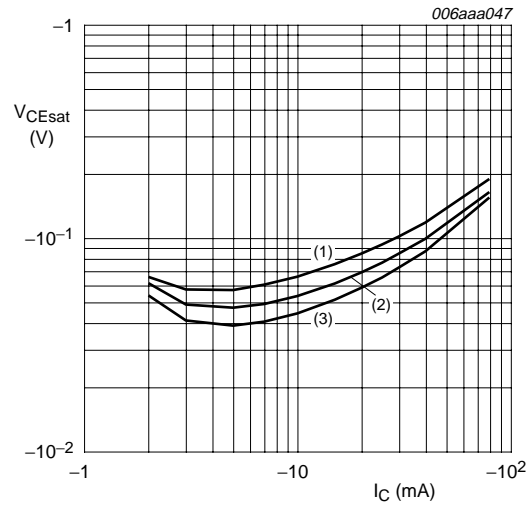
TR1; NPN: $V_{CE} = 5 \text{ V}$.
 (1) $T_{amb} = -40 \text{ }^\circ\text{C}$.
 (2) $T_{amb} = 25 \text{ }^\circ\text{C}$.
 (3) $T_{amb} = 100 \text{ }^\circ\text{C}$.

Fig 4. Off-state input voltage as a function of collector current; typical values.



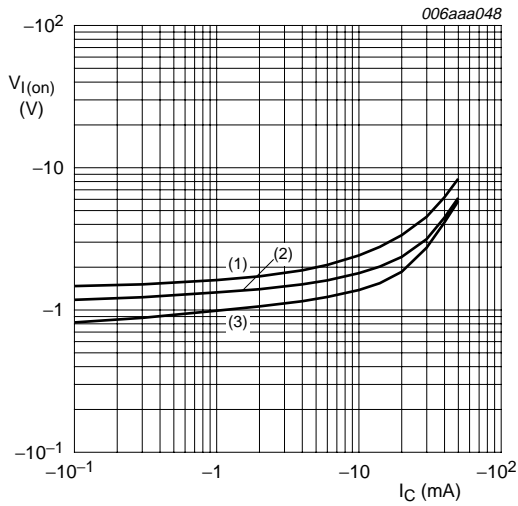
TR2; PNP: $V_{CE} = -5$ V.
 (1) $T_{amb} = 150$ °C.
 (2) $T_{amb} = 25$ °C.
 (3) $T_{amb} = -40$ °C.

Fig 5. DC current gain as a function of collector current; typical values.



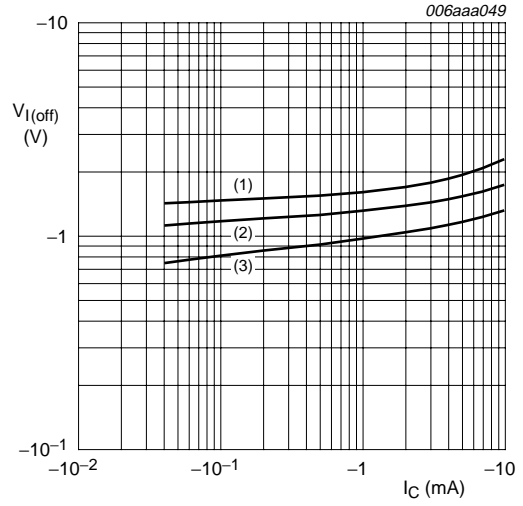
TR2; PNP: $I_C/I_B = 20$.
 (1) $T_{amb} = 100$ °C.
 (2) $T_{amb} = 25$ °C.
 (3) $T_{amb} = -40$ °C.

Fig 6. Collector-emitter voltage as a function of collector current; typical values.



TR2; PNP: $V_{CE} = -0.3$ V.
 (1) $T_{amb} = -40$ °C.
 (2) $T_{amb} = 25$ °C.
 (3) $T_{amb} = 100$ °C.

Fig 7. On-state input voltage as a function of collector current; typical values.



TR2; PNP: $V_{CE} = -5$ V.
 (1) $T_{amb} = -40$ °C.
 (2) $T_{amb} = 25$ °C.
 (3) $T_{amb} = 100$ °C.

Fig 8. Off-state input voltage as a function of collector current; typical values.

8. Package outline

Plastic surface mounted package; 6 leads

SOT363

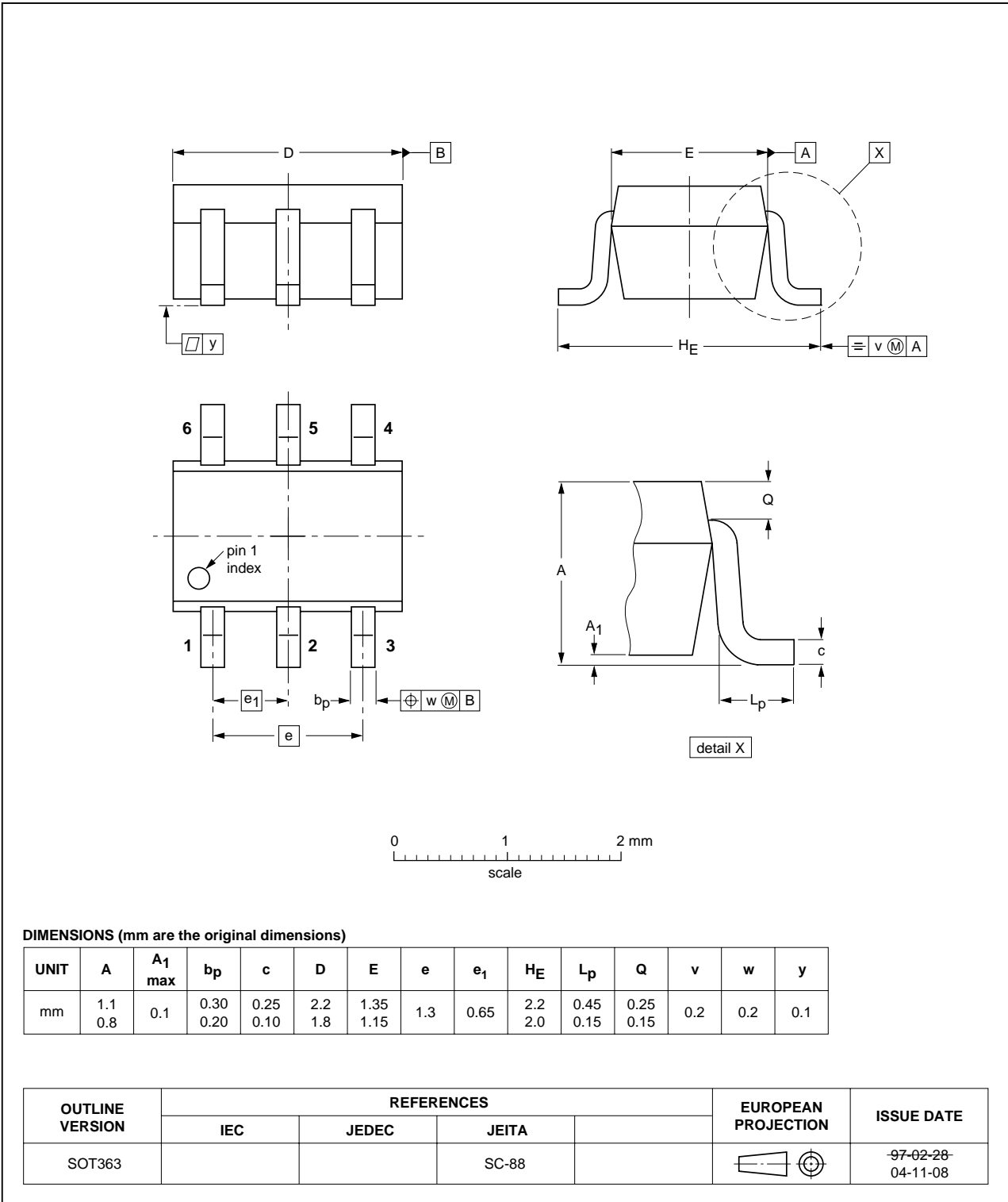


Fig 9. Package outline SOT363 (SC-88).

Plastic surface mounted package; 6 leads

SOT457

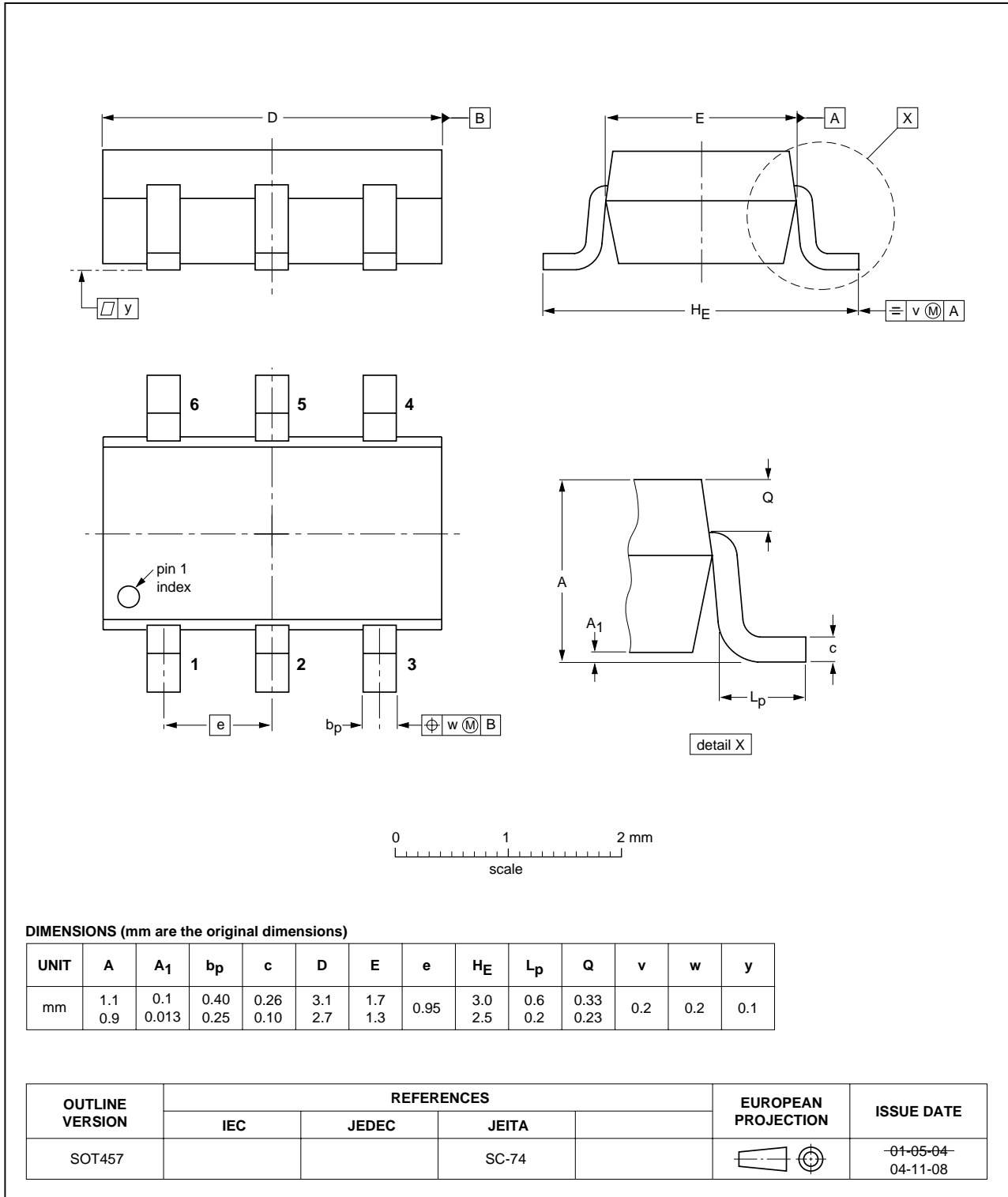


Fig 10. Package outline SOT457 (SC-74).

Plastic surface mounted package; 6 leads

SOT666

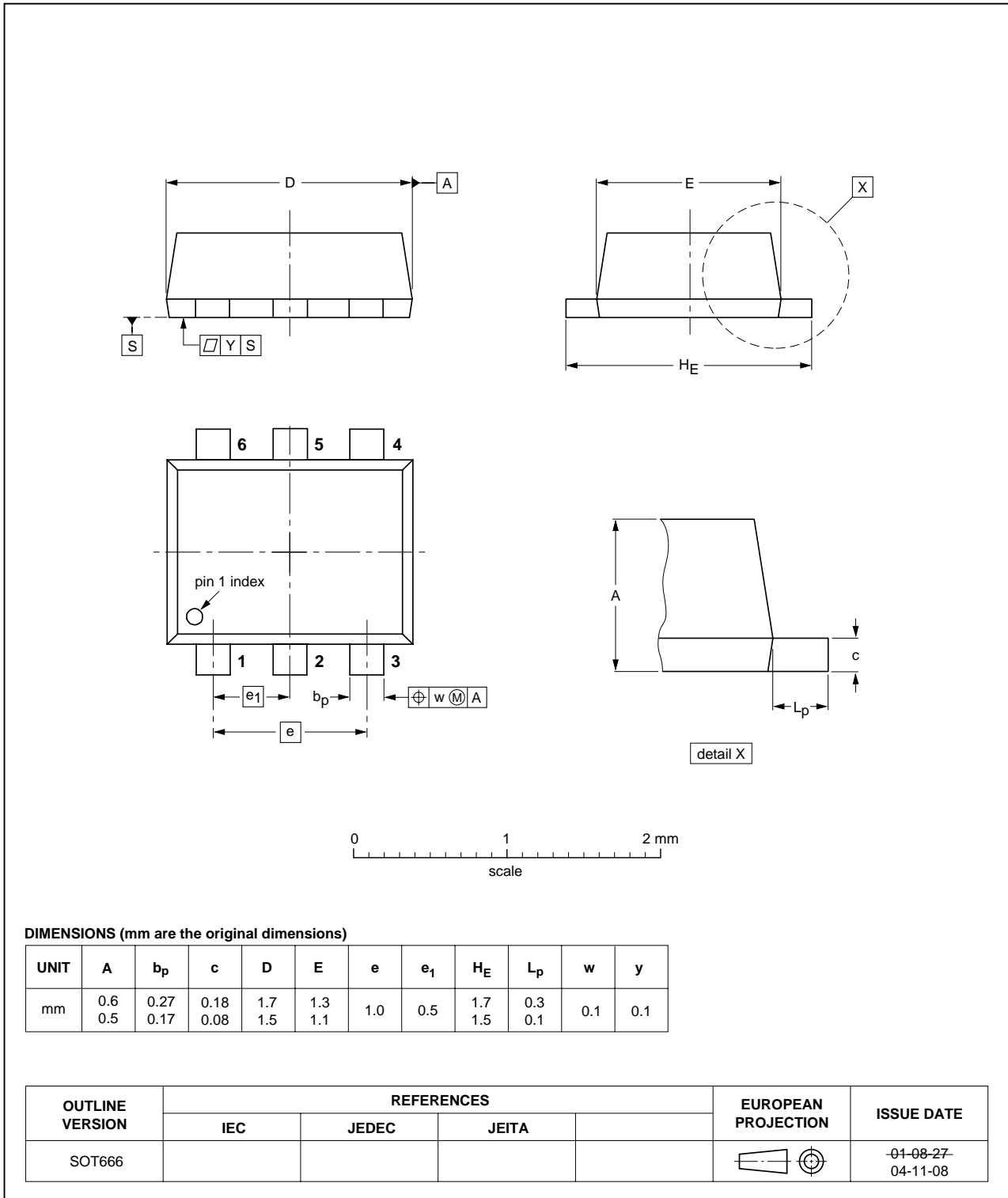


Fig 11. Package outline SOT666.

9. Packing information

Table 9: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [\[1\]](#)

Type number	Package	Description	Packing quantity		
			3000	4000	10000
PEMD3	SOT666	4 mm pitch, 8 mm tape and reel	-	-115	-
PIMD3	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2] -115	-	-135
PIMD3	SOT457	4 mm pitch, 8 mm tape and reel; T2	[3] -125	-	-165
PUMD3	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2] -115	-	-135
PUMD3	SOT363	4 mm pitch, 8 mm tape and reel; T2	[3] -125	-	-165

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] T1: normal taping.

[3] T2: reverse taping.

10. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
PEMD3_PIMD3_PUMD3_8	20041206	Product data sheet	-	9397 750 13294	PEMD3_PUMD3_7
Modifications: <ul style="list-style-type: none"> • This data sheet is an enhancement of data sheet PEMD3_PUMD3_7. • The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors. • Type PIMD3 added • Table 8 Characteristics: V_i renamed to V_I, $V_{i(on)}$ input-on voltage renamed to $V_{I(on)}$ on-state input voltage, $V_{i(off)}$ input-off voltage renamed to $V_{I(off)}$ off-state input voltage • Figure 1, 2, 3, 4, 5, 6, 7 and 8 electrical graphs for TR1 (NPN) and TR2 (PNP) added • Table 9 Packing methods added 					
PEMD3_PUMD3_7	20040414	Product specification	-	9397 750 13095	PEMD3_PUMD3_6

11. Data sheet status

Level	Data sheet status ^[1]	Product status ^[2] ^[3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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